

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{GS}	Gate-source voltage	±25	V
I _D	Drain current (continuous) at T _C = 25 °C	11	Α
I _D	Drain current (continuous) at T _C = 100 °C	7	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	44	Α
P _{TOT}	Total dissipation at T _C = 25 °C	110	W
dv/dt ⁽²⁾	Peak diode recovery voltage slope	15	V/ns
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	50	V/ns
T _{stg}	Storage temperature range	-55 to 150	°C
T _j	Operating junction temperature range	-55 to 150	

- 1. Pulse width limited by safe operating area.
- 2. $I_{SD} \le 11$ A, $di/dt \le 400$ A/ μ s, $V_{DS\ peak} < V_{(BR)DSS}$, $V_{DD} = 400$ V.
- 3. $V_{DS} \le 480 \text{ V}$

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	1.14	°C/W
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb	50	°C/W

1. When mounted on FR-4 board of 1 inch², 2 oz Cu

Table 3. Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by T _{jmax})	2.8	Α
E _{AS}	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$, $V_{DD} = 50$ V)	125	mJ

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2 Electrical characteristics

 T_C = 25 °C unless otherwise specified

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	600			V
		V _{GS} = 0 V, V _{DS} = 600 V			1	μA
I _{DSS}	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V},$ $T_{C} = 125 ^{\circ}\text{C}^{(1)}$			100	μA
I _{GSS}	Gate-body leakage current	V _{DS} = 0 V, V _{GS} = ±25 V			±10	μA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3.25	4	4.75	V
R _{DS(on)}	Static drain-source on-resistance	V _{GS} = 10 V, I _D = 5.5 A		0.340	0.378	Ω

^{1.} Defined by design, not subject to production test.

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	590	-	pF
C _{oss}	Output capacitance	V_{DS} = 100 V, f = 1 MHz, V_{GS} = 0 V	-	30	-	pF
C _{rss}	Reverse transfer capacitance		-	1.1	-	pF
Coss eq. (1)	Equivalent output capacitance	V _{DS} = 0 to 480 V, V _{GS} = 0 V	-	148	-	pF
R _G	Intrinsic gate resistance	f = 1 MHz, I _D = 0 A	-	7	-	Ω
Qg	Total gate charge	V _{DD} = 480 V, I _D = 11 A,	-	17	-	nC
Q _{gs}	Gate-source charge	V _{GS} = 0 to 10 V	-	3.1	-	nC
Q _{gd}	Gate-drain charge	(see Figure 15. Test circuit for gate charge behavior)	-	7.3	-	nC

^{1.} $C_{\text{oss eq.}}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS} .

Table 6. Switching energy

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
E _(off)	Turn-off energy (from 90% V _{GS} to 0% I _D)	V _{DD} = 400 V, I _D = 1.5 A,	-	4.7	_	μJ
		$R_G = 4.7 \Omega, V_{GS} = 10 V$				
		V_{DD} = 400 V, I_{D} = 3.5 A,	_	5.2	_	μJ
		$R_G = 4.7 \Omega$, $V_{GS} = 10 V$				μυ

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Table 7. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V _{DD} = 300 V, I _D = 5.5 A,	-	11	-	ns
t _r	Rise time	R_G = 4.7 Ω , V_{GS} = 10 V (see Figure 14. Test circuit for resistive load switching times and Figure 19. Switching time waveform)	-	10	-	ns
t _{d(off)}	Turn-off delay time		-	40	-	ns
t _f	Fall time		-	15	-	ns

Table 8. Source drain diode

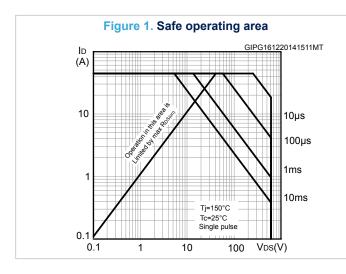
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		11	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		44	Α
V _{SD} ⁽²⁾	Forward on voltage	V _{GS} = 0 V, I _{SD} = 11 A	-		1.6	V
t _{rr}	Reverse recovery time	$I_{SD} = 11 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s,}$	-	280		ns
Q _{rr}	Reverse recovery charge	V _{DD} = 60 V	_	2.7		μC
I _{RRM}	Reverse recovery current	(see Figure 16. Test circuit for inductive load switching and diode recovery times)	-	19.5		Α
t _{rr}	Reverse recovery time	I _{SD} = 11 A, di/dt = 100 A/μs,	-	400		ns
Q _{rr}	Reverse recovery charge	V_{DD} = 60 V, T_j = 150 °C	-	3.8		μC
I _{RRM}	Reverse recovery current	(see Figure 16. Test circuit for inductive load switching and diode recovery times)	-	19		Α

- 1. Pulse width is limited by safe operating area.
- 2. Pulsed: pulse duration = 300 μ s, duty cycle 1.5%

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2.1 Electrical characteristics (curves)



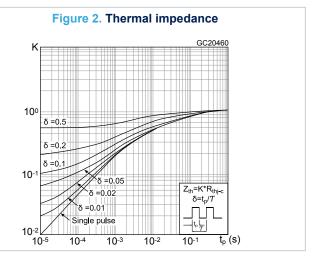
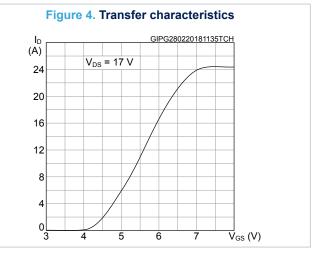
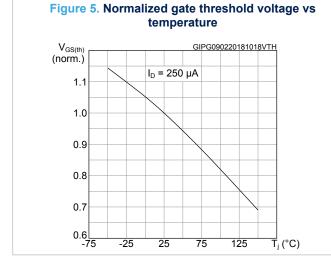
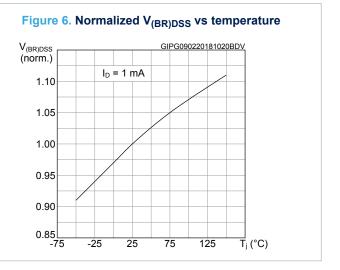


Figure 3. Output characteristics GIPG280220181135OCH I_D (A) $V_{GS} = 8, 9, 10 V$ 24 V_{GS} =7 V 20 16 V_{GS} =6 V 12 V_{GS} =5 V 0 12 16 8 $\overline{V}_{DS}(V)$







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0.340

0.330

0.320

2

Figure 7. Static drain-source on-resistance GIPG121220141431MT RDS(on) (Ω) Vgs=10V 0.360 0.350

Figure 8. Normalized on-resistance vs temperature $R_{DS(on)}$ (norm.) GIPG090220181019RON V_{GS} = 10 V2.5 2.0 1.5 1.0 0.5 0.0 -75

75

125

T_j (°C)

-25

25

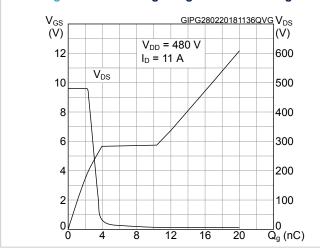
Figure 9. Gate charge vs gate-source voltage

6

8

10

ID(A)



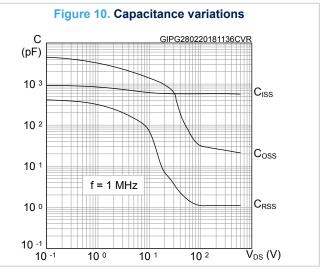


Figure 11. Turn-off switching energy vs drain current

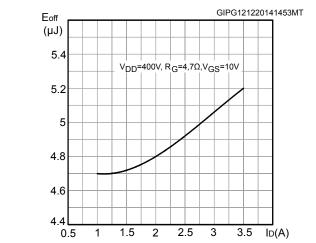
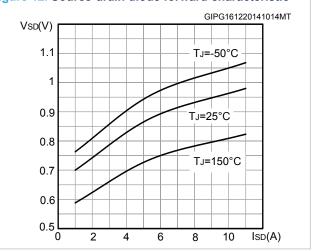
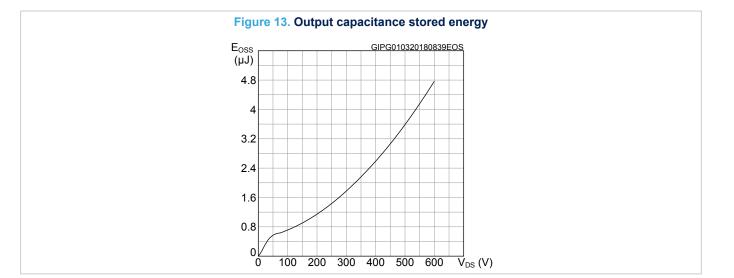


Figure 12. Source-drain diode forward characteristic



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3 Test circuits

Figure 14. Test circuit for resistive load switching times

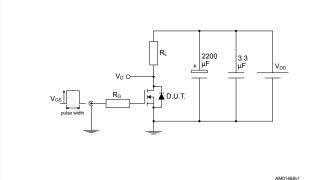


Figure 15. Test circuit for gate charge behavior

1

Figure 16. Test circuit for inductive load switching and diode recovery times

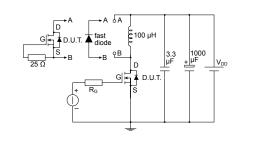
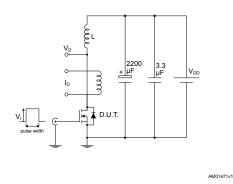


Figure 17. Unclamped inductive load test circuit



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Figure 18. Unclamped inductive waveform

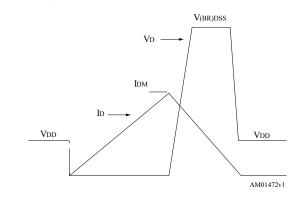
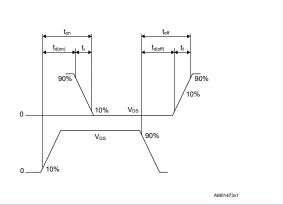


Figure 19. Switching time waveform



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4 Package mechanical data

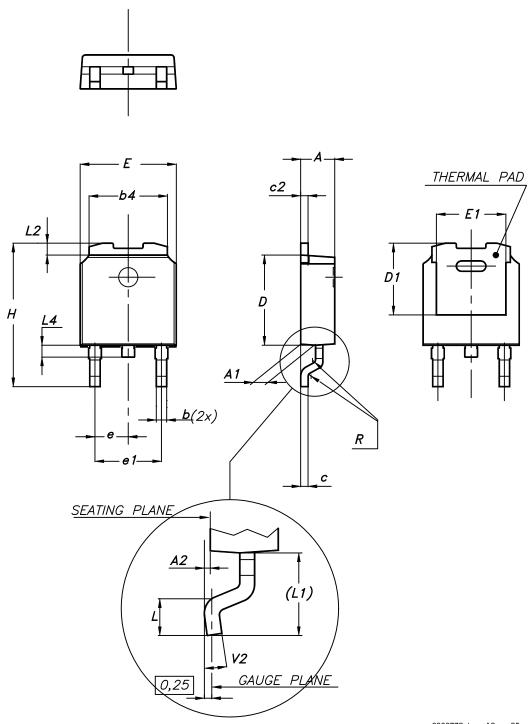
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DPAK (TO-252) type A 4.1

Figure 20. DPAK (TO-252) type A2 package outline



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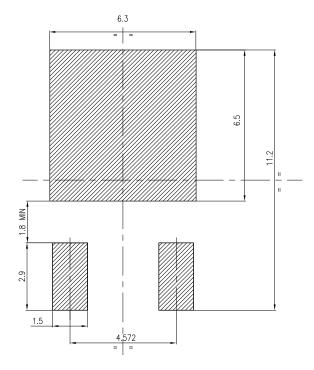


Table 9. DPAK (TO-252) type A2 mechanical data

Dim.		mm	
Dilli.	Min.	Тур.	Max.
A	2.20		2.40
A1	0.90		1.10
A2	0.03		0.23
b	0.64		0.90
b4	5.20		5.40
С	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
D1	4.95	5.10	5.25
E	6.40		6.60
E1	5.10	5.20	5.30
е	2.159	2.286	2.413
e1	4.445	4.572	4.699
Н	9.35		10.10
L	1.00		1.50
L1	2.60	2.80	3.00
L2	0.65	0.80	0.95
L4	0.60		1.00
R		0.20	
V2	0°		8°



Figure 21. DPAK (TO-252) recommended footprint (dimensions are in mm)



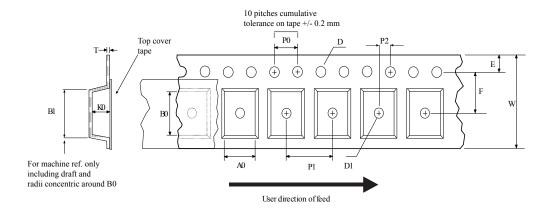
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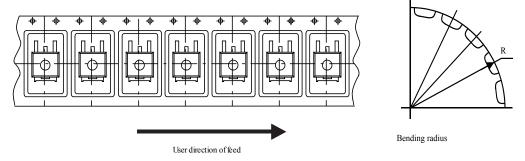
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4.2 DPAK (TO-252) packing information

Figure 22. DPAK (TO-252) tape outline



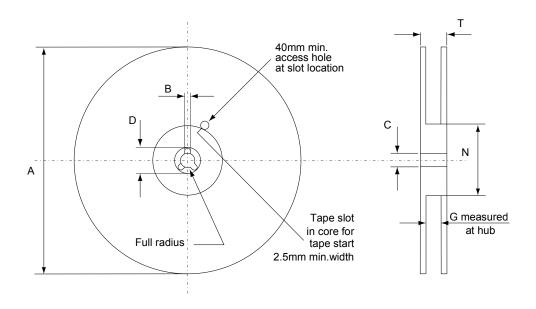


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Figure 23. DPAK (TO-252) reel outline



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Table 10. DPAK (TO-252) tape and reel mechanical data

Таре			Reel			
Dim.	r	nm	Dim.		mm	
Dim.	Min.	Max.	Dim.	Min.	Max.	
A0	6.8	7	А		330	
В0	10.4	10.6	В	1.5		
B1		12.1	С	12.8	13.2	
D	1.5	1.6	D	20.2		
D1	1.5		G	16.4	18.4	
Е	1.65	1.85	N	50		
F	7.4	7.6	Т		22.4	
K0	2.55	2.75				
P0	3.9	4.1	Bas	e qty.	2500	
P1	7.9	8.1	Bul	k qty.	2500	
P2	1.9	2.1				
R	40					
Т	0.25	0.35				
W	15.7	16.3				

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Revision history

Table 11. Document revision history

Date	Revision	Changes
11-May-2015	1	First release.
		Removed maturity status indication from cover page. The document status is production data.
12-Mar-2018	2	Updated Section 1 Electrical ratings, Section 2 Electrical characteristics and Section 2.1 Electrical characteristics (curves).
		Updated Section 4.1 DPAK (TO-252) type A2 package information.
		Updated Table 1. Absolute maximum ratings, Table 5. Dynamic, Table 6. Switching energy and Table 8. Source drain diode.
05-Jun-2018	3	Updated Figure 1. Safe operating area and Figure 11. Turn-off switching energy vs drain current.
		Minor text changes







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